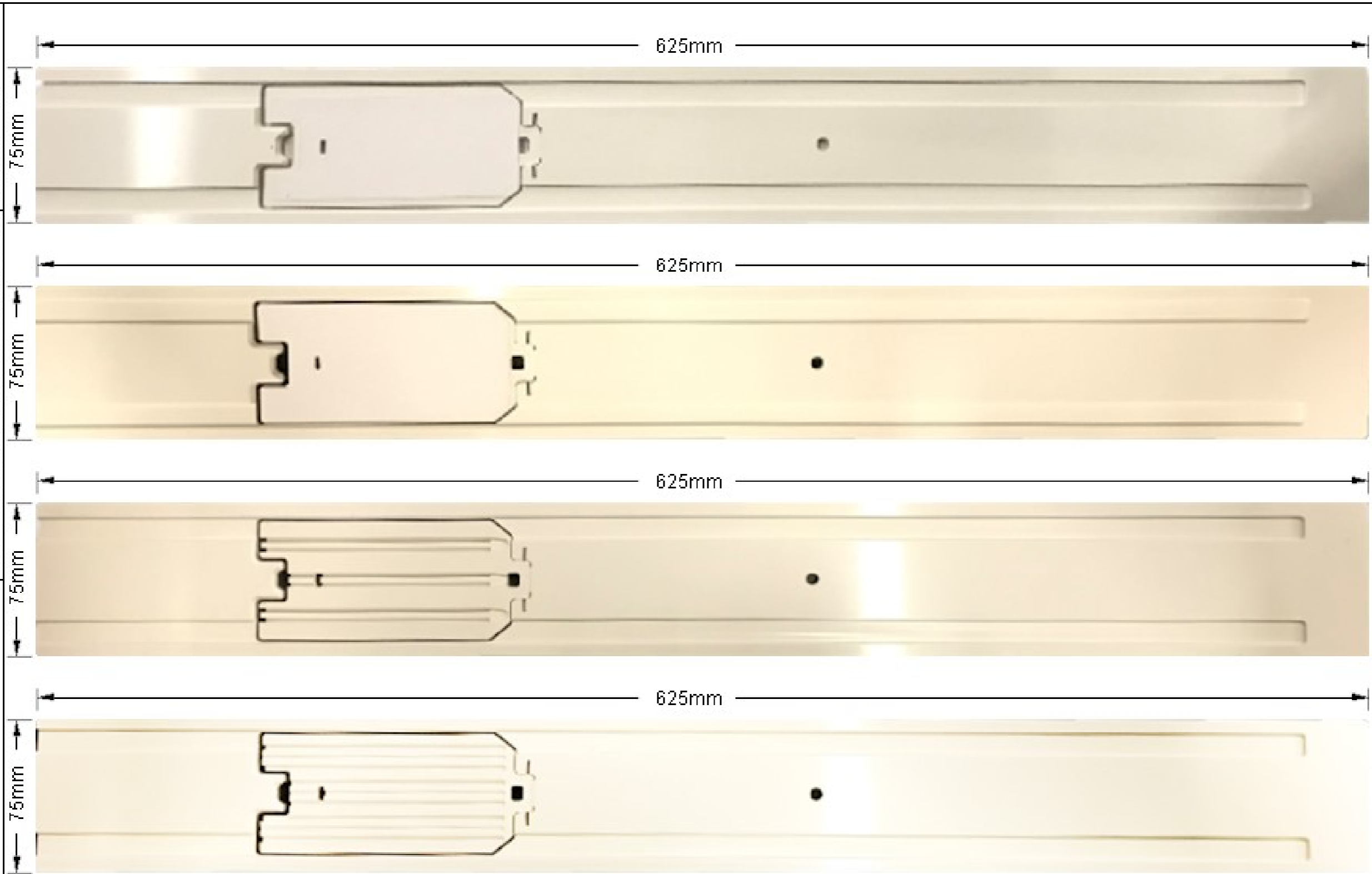


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USED ON	-
TCPN DESCRIPTION:	HTP500-BA4
TCPN:	18NA235712R2400
TCPN DESCRIPTION:	HTP500-PL
TCPN:	18NA235704R0500
TCPN DESCRIPTION:	HTP500-PL1
TCPN:	18NA235723R0000
TCPN DESCRIPTION:	HTP500-PL2
TCPN:	18NA235705R0600

REV	DATE	BY	CHK	APP	DESCRIPTION
1	-	-	-	-	-
P	LTR	REVISION RECORD	DATE	DWVN	APPVD

DIMENSIONS:	TOLERANCES UNLESS OTHERWISE SPECIFIED:	
m/m	0 PLC	± -
	1 PLC	± -
ANGLES ± °	2 PLC	± -
SURFACE TEXTURE	3 PLC	± -
	4 PLC	± -

DWVN	19FEB2021	MATERIAL	-	HEAT TREAT	-
S CAROLAN					
CHK	-				
APVD	19FEB2021	NAME			
L SMITH		HTP500 SUPPORT KIT			
SCALE	SIZE	DRAWING NO.	SHEET	OF	REV
2:1	A3	MCD 200023	1	1	1